



## General Description

The MAX811xEUS+T is low-power microprocessor ( $\mu$ P) supervisory circuits used to monitor power supplies in  $\mu$ P and digital systems.

They provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with 5V-powered or 3V-powered circuits.

The MAX811xEUS+T also provide a debounced manual reset input. The only difference between the two devices is that the MAX811xEUS+T has an active-low RESET output (which is guaranteed to be in the correct state for VCC down to 1V). Reset thresholds are available for operation with a variety of supply voltages.

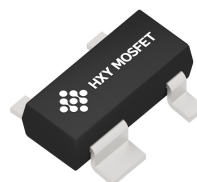
## Features

- Precision Monitoring of 3V, 3.3V, and 5V Power-Supply Voltages
- 140ms Min Power-On Reset Pulse Width
- Guaranteed Over Temperature
- Guaranteed RESET Valid to VCC = 1V
- SOT-143 package

## Selection Table

Part No	Detectable Voltage	Package
MAX811LEUS+T	4.63V	SOT-143 (SOT-143-4)
MAX811MEUS+T	4.38V	
MAX811TEUS+T	3.08V	
MAX811SEUS+T	2.93V	
MAX811REUS+T	2.63V	

## Pin Assignment



Pin 1

SOT-143(SOT-143-4)

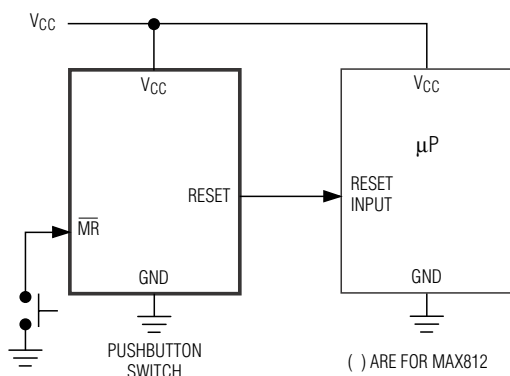
PIN NO	PIN NAME	FUNCTION
1	GND	Ground
2	RESET	Active-Low Reset Output
3	MR	Manual Reset Input
4	VCC	Supply Voltage

## Applications

- Computers
- Controllers
- Intelligent Instruments
- Portable/Battery-Powered Equipment



## Application Circuits



## Absolute Maximum Ratings

Input Voltage .....-0.3V to 6.0V      Storage Temperature .....-40°C to 125°C

Operating Temperature .....-40°C to 85°C

Note: These are stress ratings only. Stresses exceeding the range specified under “Absolute Maximum Ratings” may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

## Thermal Information

Symbol	Parameter	Max.	Unit
$\theta_{JA}$	Thermal Resistance (Junction to Ambient) (Assume no ambient airflow, no heat sink)	260	°C/W
$P_D$	Power Dissipation	0.32	W

Note:  $P_D$  is measured at  $T_a = 25^\circ\text{C}$

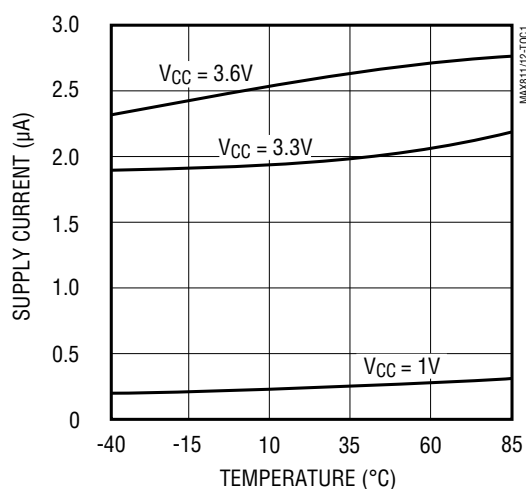


## Electrical Characteristics

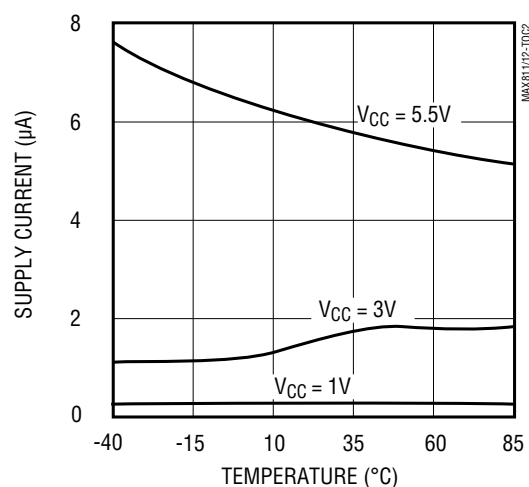
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>CC</sub>	Input Voltage (V <sub>CC</sub> ) Range	TA=25°C	1.2		5.5	V
I <sub>SS</sub>	Supply Current	MAX811L/M: V <sub>CC</sub> < 5.5V MAX811R/S/T: V <sub>CC</sub> < 3.6V		6 2.7	15 10	μA
V <sub>DET</sub>	Reset Threshold	MAX811L: TA=25°C	4.54	4.63	4.72	V
		MAX811M: TA=25°C	4.30	4.38	4.46	
		MAX811T: TA=25°C	3.03	3.08	3.14	
		MAX811S: TA=25°C	2.88	2.93	2.98	
		MAX811R: TA=25°C	2.58	2.63	2.68	
	Reset Threshold Stability			30		Ppm/ °C
	V <sub>CC</sub> to Reset Delay	V <sub>OD</sub> =125mV, MAX811L/M: V <sub>OD</sub> =125mV, MAX811R/S/T:		40 20		us
t <sub>RP</sub>	Reset Threshold Tempco	V <sub>CC</sub> =V <sub>TH</sub> (MAX)	140		560	ms
t <sub>MR</sub>	MR Minimum Pulse Width Tempco		10			us
	MR Glitch Immunity			100		ns
t <sub>MD</sub>	MR to Reset Propagation Delay			0.5		us
V <sub>IH</sub>	MR Input Threshold	V <sub>CC</sub> > V <sub>TH</sub> (MAX), MAX811L/M	2.3			V
V <sub>IL</sub>					0.8	
V <sub>IH</sub>		V <sub>CC</sub> > V <sub>TH</sub> (MAX), MAX811R/S/T	0.7xV <sub>CC</sub>			
V <sub>IL</sub>					0.25xV <sub>CC</sub>	
t <sub>MD</sub>	MR Pull-Up Resistance		10	20	30	kΩ
V <sub>OL</sub>	RESET Output Voltage Low	MAX811L/M: V <sub>CC</sub> =V <sub>TH</sub> min, I <sub>SINK</sub> =1.2mA MAX811R/S/T: V <sub>CC</sub> =V <sub>TH</sub> min, I <sub>SINK</sub> =3.2mA I <sub>SINK</sub> =50uA, V <sub>CC</sub> > 1.0V			0.4 0.3	V
V <sub>OH</sub>	RESET Output Voltage High	MAX811L/M only, I <sub>SOURCE</sub> =150uA MAX811R/S/T only, I <sub>SOURCE</sub> =150uA V <sub>CC</sub> > V <sub>TH</sub> (MAX)	0.8 V <sub>CC</sub> V <sub>CC</sub> -1.5			V



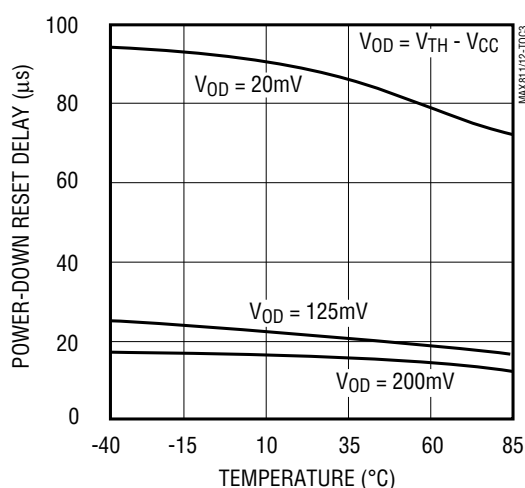
## Typical Characteristics



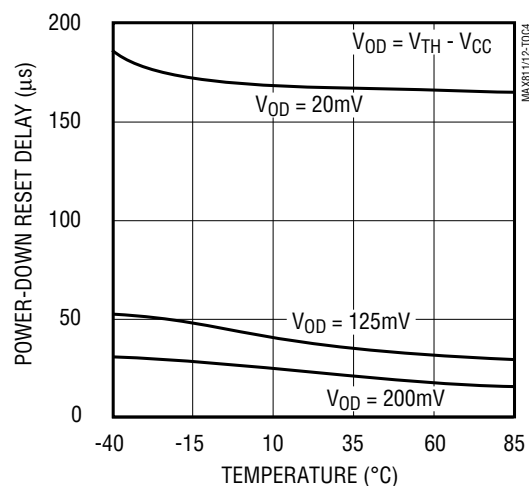
Supply Current vs Temperature  
(No Load, MAX811R/S/T)



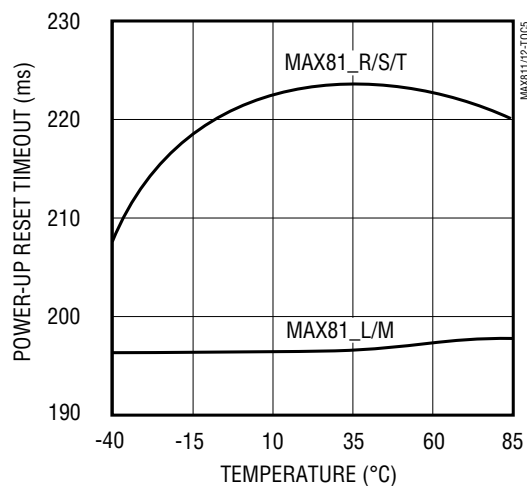
Supply Current vs Temperature  
(No Load, MAX811L/M)



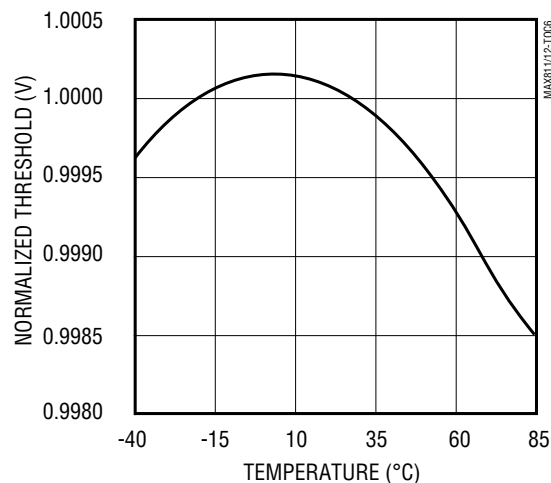
Power-Down Reset Delay vs  
Temperature and (MAX811R/S/T)



Power-Down Reset Delay vs  
Temperature and (MAX811L/M)



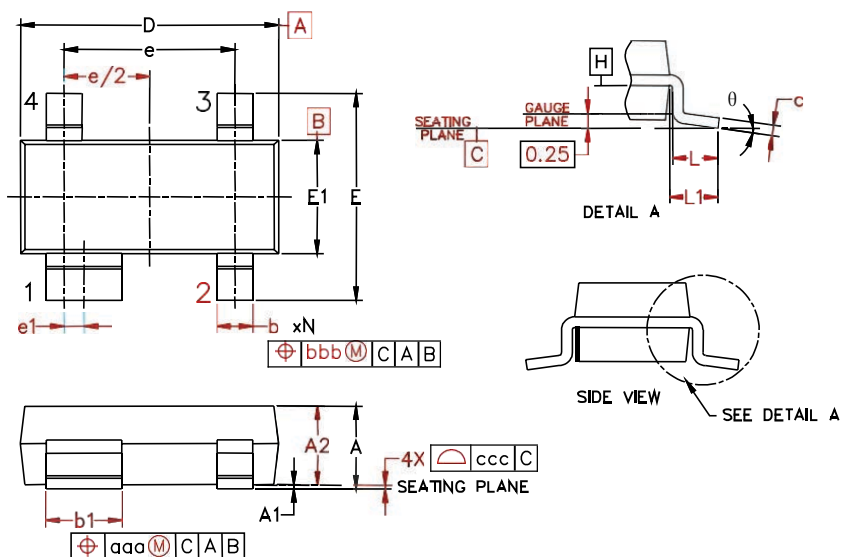
Power-Up Reset Timeout vs  
Temperature



Normalized Reset Threshold vs  
Temperature



## SOT-143(SOT-143-4) Package Outline Dimensions



Symbol	Inches			Millimeters		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.031	-	0.048	0.80	-	1.22
A1	0.000	-	0.008	0.013	-	0.15
A2	0.020	0.035	0.042	0.75	0.90	1.07
b	0.011	-	0.020	0.30	-	0.51
b1	0.029	-	0.037	0.76	-	0.94
c	0.003	-	0.008	0.08	-	0.20
D	0.110	0.114	0.120	2.80	2.90	3.04
E	0.082	0.093	0.104	2.10	2.37	2.64
E1	0.047	0.051	0.055	1.20	1.30	1.40
e	0.075			1.92 BSC		
e1	0.008			0.20 BSC		
L	0.015	0.020	0.024	0.40	0.50	0.60
L1	(0.021)			(0.54)		
N	4			4		
θ	0°	-	8°	0°	-	8°
aaa	0.006			0.15		
bbb	0.008			0.20		
ccc	0.004			0.10		



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